

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT4104468

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JOHN FOX	06/17/2016
PETER HUNT	06/23/2016
JOHN D. KEAY	06/17/2016
RICHARD SIMPSON	06/17/2016
ANDREW KEVIN JOHN STEWART	06/17/2016
GIUSEPPE SURACE	06/17/2016
BRIAN HOLDEN	07/01/2016
AMIN SHOKROLLAHI	06/15/2016
ROGER ULRICH	06/15/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	KANDOU LABS, S.A.
<b>Street Address:</b>	EPFL INNOVATION PARK
<b>Internal Address:</b>	BUILDING I
<b>City:</b>	LAUSANNE
<b>State/Country:</b>	SWITZERLAND
<b>Postal Code:</b>	1015
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15176084
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Email:</b>	alec@inventionmine.com, olga@inventionmine.com
<b>Correspondent Name:</b>	INVENTION MINE, LLC
<b>Address Line 1:</b>	216 S. JEFFERSON ST.
<b>Address Line 2:</b>	SUITE 102
<b>Address Line 4:</b>	CHICAGO, ILLINOIS 60661
<b>ATTORNEY DOCKET NUMBER:</b>	KDU-71919US04

<b>NAME OF SUBMITTER:</b>	ROBERT J. IRVINE III
<b>SIGNATURE:</b>	/Robert J. Irvine III/
<b>DATE SIGNED:</b>	10/19/2016
<b>Total Attachments: 9</b> source=KDU-71919US04-Executed Assignment All Inventors#page1.tif source=KDU-71919US04-Executed Assignment All Inventors#page2.tif source=KDU-71919US04-Executed Assignment All Inventors#page3.tif source=KDU-71919US04-Executed Assignment All Inventors#page4.tif source=KDU-71919US04-Executed Assignment All Inventors#page5.tif source=KDU-71919US04-Executed Assignment All Inventors#page6.tif source=KDU-71919US04-Executed Assignment All Inventors#page7.tif source=KDU-71919US04-Executed Assignment All Inventors#page8.tif source=KDU-71919US04-Executed Assignment All Inventors#page9.tif	

**ASSIGNMENT**  
(Patent Application)

I, the undersigned, have invented certain inventions and improvements disclosed in a utility (provisional or non-provisional) or design patent application entitled

**"METHODS AND SYSTEMS FOR HIGH BANDWIDTH CHIP-TO-CHIP  
COMMUNICATIONS INTERFACE"**

the specification of which is provided with this Assignment and identified by the Attorney Docket No. above. (Serial No. 15/176,084) filed on June 7, 2016.

For one dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which I acknowledge, I:

1. Agree to assign, transfer, convey, and sell, hereby assign, transfer, convey, and sell and have assigned, transferred, conveyed, and sold to Kandou Labs, S.A., a Corporation, having a principal place of business at EPFL Innovation Park, Building I, Lausanne, Switzerland CH-1015 ("Assignee"), the entire right, title, and interest in and to:
  - (a) all intellectual property (including, without limitation, any innovation, information, invention, discovery, product, process, work or design) disclosed, embodied, shown, or claimed in the above-referenced patent application, implicitly or explicitly;
  - (b) the above-referenced patent application, the right to claim priority to the above-referenced patent application, all applications based in whole or in part upon the above-referenced patent application, including, without limitation, all applications that are a provisional, non-provisional, design, divisional, continuation, continuation-in-part, registration, utility model, industrial design, reissue, renewal, substitute, extension, reexamination, post-grant review, inter partes review, supplemental examination or non-U.S. patent application or application for other rights based in whole or in part on the above-referenced patent application;
  - (c) all patents (including, without limitation, all U.S. and non-U.S. patents, registrations, utility models, industrial designs, design patents, counterparts, continuations, continuations-in-part, divisionals, reissues, renewals, substitutes, extensions, reexaminations, post-grant reviews, inter partes reviews and supplemental examinations) that are granted or issued upon, or that claim priority to, any and all applications described in (b) of this paragraph or that disclose or claim intellectual property described in (a) of this paragraph, in whole or in part; and

ASSIGNMENT

Attorney Docket No. KDU-71919US04

Page 2 of 3

- (d) all claims for damages by reason of past infringement of any rights under the applications or patents described in (a), (b) or (c) of this paragraph (including provisional rights to reasonable royalties pursuant to 35 U.S.C. §154(d)) and the right to sue for and collect such damages and royalties for Assignee's own use.
2. Authorize and request the U.S. Patent and Trademark Office or any other U.S. or non-U.S. agency to issue to the Assignee any and all patent(s), or other rights or documents, resulting from the intellectual property, patent application(s) and patents described in paragraph 1 of this Assignment.
  3. Agree to sign all papers and documents, including without limitation, applications, declarations, oaths and petitions, and, at the Assignee's expense, perform any other acts that are necessary in connection with prosecution of patent application(s) or intellectual property described in paragraph 1 of this Assignment and the enforcement of patent(s) or other rights resulting from such patent application(s) or intellectual property.
  4. Agree that the terms, covenants, and conditions of this Assignment shall inure to the benefit of the Assignee, its successors, assigns and other legal representative, and shall be binding upon us, as well as our heirs, legal representatives, and assigns.
  5. Promise and affirm that I have not entered, and will not enter, into any assignment, contract, or understanding that conflicts with this Assignment.
  6. Authorize Invention Mine LLC to insert above the application number and filing date of the above-described patent application when known.

Signed on the dates indicated beside my signature:

Signature: \_\_\_\_\_

John Fox

Date: \_\_\_\_\_

17-Jun-2016

PATENT

REEL: 040066 FRAME: 0990

ASSIGNMENT

Attorney Docket No. KDU-71919US04

Page 3 of 3

Signature: \_\_\_\_\_

Brian Holden

Date: \_\_\_\_\_

Signature: Peter Hunt

Peter Hunt

Date: 23/06/16

Signature: John D. Keay

John D. Keay

Date: 17/6/16

Signature: \_\_\_\_\_

Amin Shokrollahi

Date: \_\_\_\_\_

Signature: Richard Simpson

Richard Simpson

Date: 17/6/16

Signature: \_\_\_\_\_

Roger Ulrich

Date: \_\_\_\_\_

Signature: Andrew Kevin John Stewart

Andrew Kevin John Stewart

Date: 17/6/16

Signature: Giuseppe Surace

Giuseppe Surace

Date: 17/6/16

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Signature: \_\_\_\_\_

John Fox

Date: \_\_\_\_\_

PATENT

REEL: 040066 FRAME: 0993

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Attorney Docket No. KDU-71919US04

Page 3 of 3

Signature: \_\_\_\_\_

Brian Holden

Date: \_\_\_\_\_

July 1, 2016

Signature: \_\_\_\_\_

Peter Hunt

Date: \_\_\_\_\_

Signature: \_\_\_\_\_

John D. Keay

Date: \_\_\_\_\_

Signature: \_\_\_\_\_

Amin Shokrollahi

Date: \_\_\_\_\_

Signature: \_\_\_\_\_

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Giuseppe Surace

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John Fox

Date: \_\_\_\_\_

PATENT

REEL: 040066 FRAME: 0996

Signature: \_\_\_\_\_

Brian Holden

Date: \_\_\_\_\_

Signature: \_\_\_\_\_

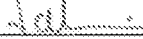
Peter Hunt

Date: \_\_\_\_\_

Signature: \_\_\_\_\_

John D. Keay

Date: \_\_\_\_\_

Signature:  \_\_\_\_\_

Amin Shokrollahi

Date: June 15, 2016

Signature: \_\_\_\_\_

Richard Simpson

Date: \_\_\_\_\_

Signature:  \_\_\_\_\_

Roger Ulrich

Date: June 15, 2016

Signature: \_\_\_\_\_

Andrew Kevin John Stewart

Date: \_\_\_\_\_

Signature: \_\_\_\_\_

Giuseppe Surace

Date: \_\_\_\_\_